

IR MOSFET™

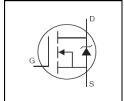
# **Features**

- Advanced Process Technology
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- · Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

# **Description**

IR MOSFET™ technology from Infineon utilizes advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and rugged device design that IR MOSFET™ devices are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole.



V <sub>(BR)DSS</sub>	200V
R <sub>DS(on)</sub> max.	0.075Ω
I <sub>D</sub>	30A



G	D	S
Gate	Drain	Source

Base part number	Packago Typo	Standard Pack		Orderable Part Number	
base part number	Package Type	ge Type Form (		Olderable Part Number	
IRFP250MPbF	TO-247AD	Tube	25	IRFP250MPbF	

### **Absolute Maximum Ratings**

Symbol	Parameter	Max.	Units	
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	30		
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	21	A	
I <sub>DM</sub>	Pulsed Drain Current ①⑤	120		
$P_D @ T_C = 25^{\circ}C$	Maximum Power Dissipation	214	W	
	Linear Derating Factor	1.4	W/°C	
$V_{GS}$	Gate-to-Source Voltage	± 20	V	
E <sub>AS</sub> Single Pulse Avalanche Energy ②⑤		315	mJ	
I <sub>AR</sub> Avalanche Current ①⑤		30	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy ①	21	mJ	
dv/dt Peak Diode Recovery dv/dt③⑤		8.6	V/ns	
$T_J$	Operating Junction and -55 to + 175			
T <sub>STG</sub>	Storage Temperature Range	-55 to + 175	°C	
	Soldering Temperature, for 10 seconds (1.6mm from case)	300		
	Mounting torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)		

### **Thermal Resistance**

Symbol	Parameter	Тур.	Max.	Units
$R_{ heta JC}$	Junction-to-Case		0.7	
$R_{ heta CS}$	Case-to-Sink, Flat, Greased Surface	0.24		°C/W
$R_{ heta JA}$	Junction-to-Ambient		40	

2020-05-28



# Electrical characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	200			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.26		V/°C	Reference to 25°C, I <sub>D</sub> = 1mA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance			0.075	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 18A ④
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
gfs	Forward Trans conductance	17			S	$V_{DS} = 50V, I_{D} = 18A@$
ı	Drain-to-Source Leakage Current			25		$V_{DS} = 200V, V_{GS} = 0V$
IDSS	Dialii-to-Source Leakage Current			250	μΑ	$V_{DS} = 160V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
	Gate-to-Source Forward Leakage			100	nΛ	$V_{GS} = 20V$
IGSS	Gate-to-Source Reverse Leakage			-100	nA	$V_{GS} = -20V$

# Dynamic Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

nd 13 ④
4
ct:

### **Diode Characteristics**

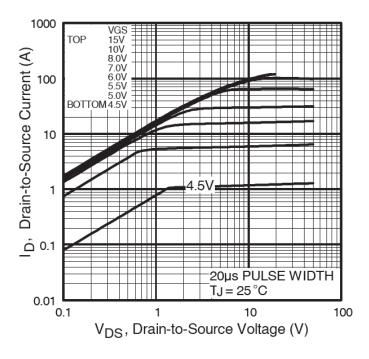
	Parameter	Min.	Тур.	Max.	Units	Conditions
I <sub>S</sub>	Continuous Source Current (Body Diode)			30	_	MOSFET symbol showing the
I <sub>SM</sub>	Pulsed Source Current (Body Diode) ①			120		integral reverse p-n junction diode.
$V_{SD}$	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C, I_S = 18A, V_{GS} = 0V $ ④
t <sub>rr</sub>	Reverse Recovery Time		186	279	ns	T <sub>J</sub> = 25°C ,I <sub>F</sub> = 18A
Q <sub>rr</sub>	Reverse Recovery Charge		1.3	2.0	μC	di/dt = 100A/µs ④

#### **Notes**

- $\, \mathbb{O} \,$  Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- ② Starting  $T_J$  = 25°C, L = 1.9mH,  $R_G$  = 25 $\Omega$ ,  $I_{AS}$  = 18A.(See fig. 12).
- $\label{eq:local_local_local} \mbox{$\Im$} \quad I_{SD} \leq 18 \mbox{$A$}, \ di/dt \leq 374 \mbox{$A/\mu$s}, \ V_{DD} \leq V_{(BR)DSS}, \ T_J \leq 175 \mbox{$^{\circ}$C}.$
- 4 Pulse width  $\leq 300 \mu s$ ; duty cycle  $\leq 2\%$ .

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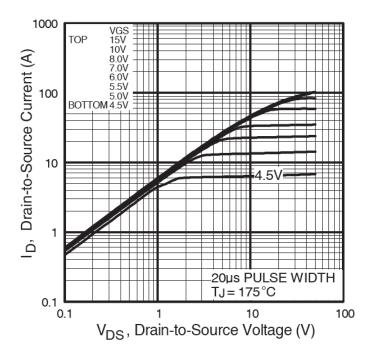
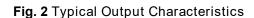
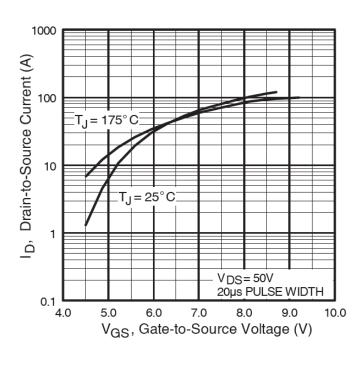


Fig. 1 Typical Output Characteristics





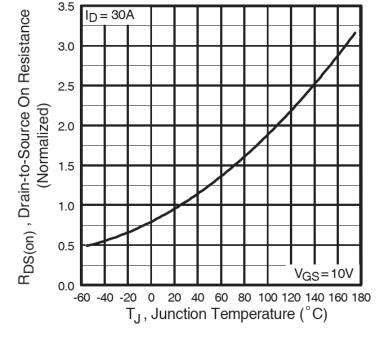
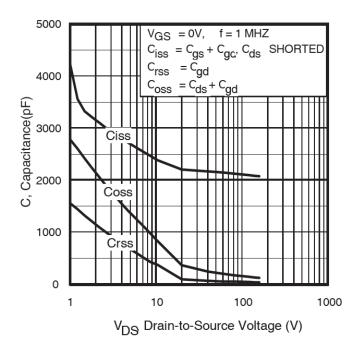
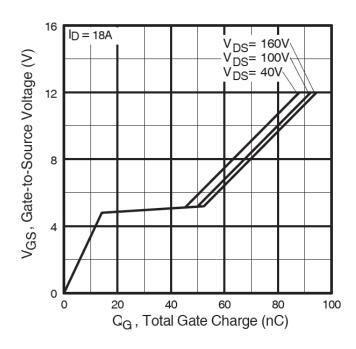


Fig. 3 Typical Transfer Characteristics

Fig. 4 Normalized On-Resistance vs. Temperature







**Fig 5.** Typical Capacitance vs. Drain-to-Source Voltage

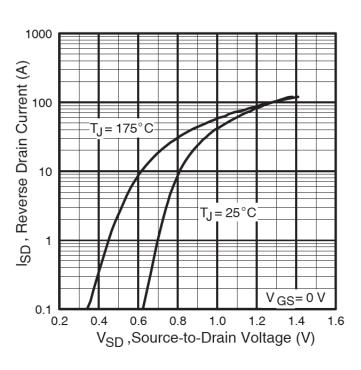


Fig. 7 Typical Source-to-Drain Diode Forward Voltage

**Fig 6.** Typical Gate Charge vs. Gate-to-Source Voltage

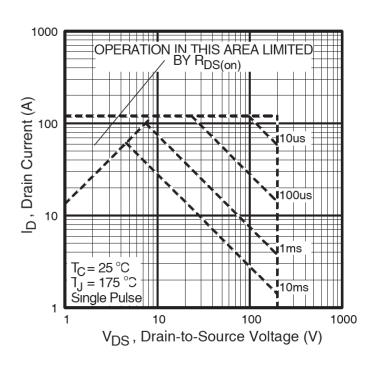


Fig 8. Maximum Safe Operating Area

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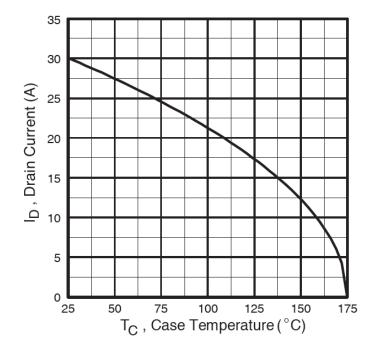


Fig 9. Maximum Drain Current vs. Case Temperature

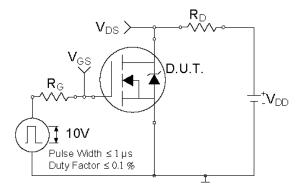


Fig 10a. Switching Time Test Circuit

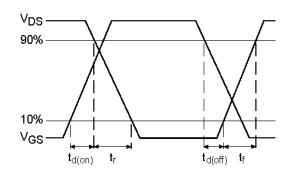


Fig 10a. Switching Time Waveforms

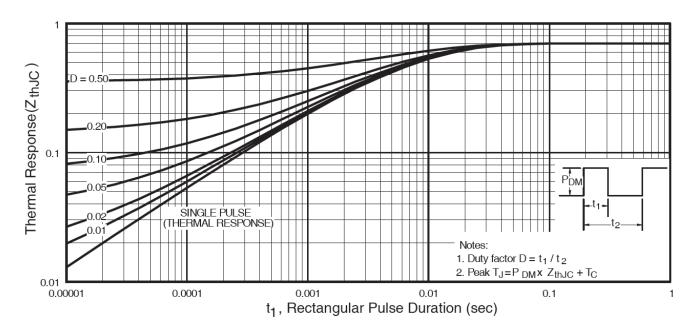


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case



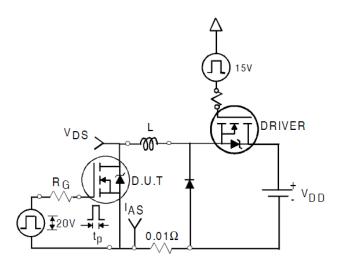


Fig. 12a. Unclamped Inductive Test Circuit

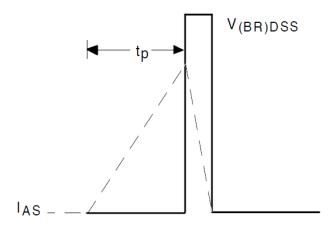


Fig. 12b. Unclamped Inductive Waveforms

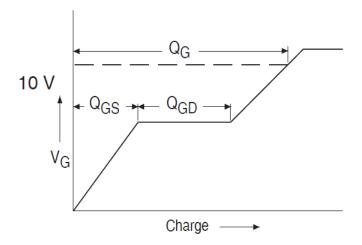
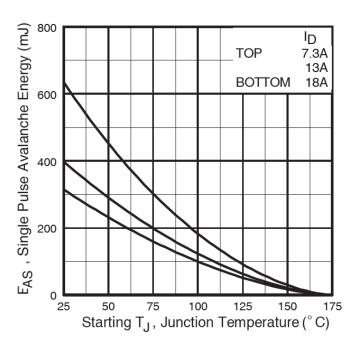


Fig 13a. Basic Gate Charge Waveform



**Fig 12c.** Maximum Avalanche Energy vs. Drain Current

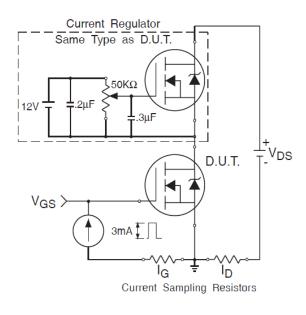
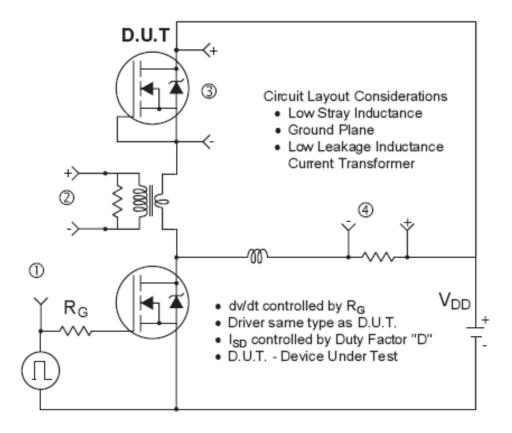
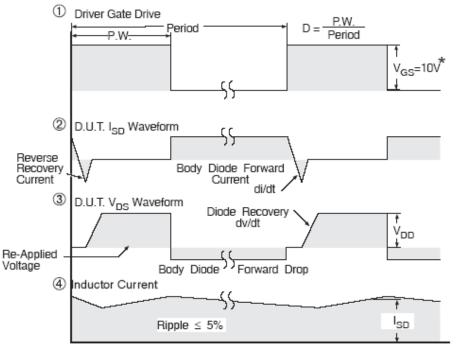


Fig 13b. Gate Charge Test Circuit





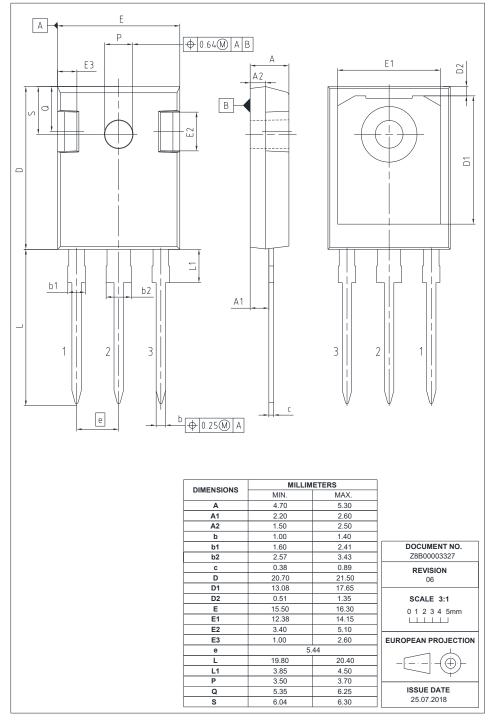


\*  $V_{GS}$  = 5V for Logic Level Devices

Fig 14. Peak Diode Recovery dv/dt Test Circuit for N-Channel IR MOSFET™



# TO-247AD Package Outline (Dimensions are shown in millimeters (inches))



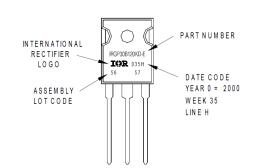
# **TO-247AD Part Marking Information**

EXAMPLE: THIS IS AN IRGP30B120KD-E WITH ASSEMBLY

LOT CODE 5657

ASSEMBLED ON WW 35, 2000 IN THE ASSEMBLY LINE "H"

Note: "P" in assembly line position indicates "Lead-Free"





### **Revision History**

Date	Comments		
05/28/2020	<ul> <li>Updated datasheet with corporate template</li> <li>Updated Package picture-page1</li> </ul>		
00/20/2020	<ul> <li>Corrected from "Hexfet power MOSFET" to "IR MOSFET™" -page1 &amp;7</li> <li>Corrected part marking from TO-247AC to TO-247AD on page 8.</li> </ul>		

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